

# **CX3HGSM AT CRYSTAL**

# **Low Profile Miniature SMD Crystal**

# 9.6MHz to 250MHz

#### **FEATURES**

- Very high shock and vibration survival
- Designed for surface mount applications, including infrared, vapour phase or epoxy mount techniques
- Hermetically sealed ceramic package
- Excellent ageing characteristics
- Available with glass or ceramic lid
- Custom designs available
- Full Military testing available

# **SPECIFICATION**

Specifications stated are typical at 25°C unless otherwise indicated. Specifications may change without notice.

Fundamental Frequency:	10.0MHz	32.0MHz	155.52MHz
Motional Resistance R (Ω):	60	25	10
Motional Capacitance C1 (fF):	2.8	6.2	4.0
Quality Factor Q (k):	95	30	30
Shunt Capacitance C0 (pF):	1.4	2.3	2.3

Calibration Tolerance<sup>1</sup>: ±100ppm or tighter as required

Load Capacitance<sup>2</sup>: 20pF for fr. <50MHz

10pF for fr. >50MHz

Drive Level: 500μW max. for fr. <50MHz 200μW max. for fr. <50MHz

Temperature Stability<sup>3</sup>

Commercial  $-10 \sim +60^{\circ}$ C:  $\pm 50$ ppm to  $\pm 10$ ppm Industrial -40 to  $+85^{\circ}$ C:  $\pm 100$ ppm to  $\pm 20$ ppm Military -55 to  $+125^{\circ}$ C:  $\pm 100$ ppm to  $\pm 30$ ppm

Ageing, first year4: 5ppm max.

Better than ±1ppm is available

Shock, survival<sup>5</sup>: Up to 20,000g, 0.3ms, ½ sine Vibration, survival<sup>6</sup>: 20g, 10~2000Hz swept sine

**Operating Temperature Range** 

Commercial: -10° to +70°C Industrial: -40° to +85°C Military: -55 to +125°C

Storage Temperature Range: -55° to +125°C

Maximum Process Temperature: +260°C for 20 seconds

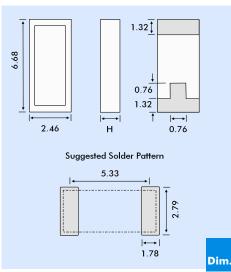
- 1. Other tolerances available, contact Euroquartz sales.
- 2. Unless specified otherwise.
- Does not include calibration tolerance. The characteristics of the frequency stability over temperature follow that of the AT thicknessshear mode.
- 5ppm max. for frequencies below 40MHz For tighter tolerances and higher frequencies contact Euroquartz sales.
- 5. Higher shock version available. See CX1HGSM
- Per MIL-STD-202G, Method 204D, Condition D. Random vibration testing also available.

## **DESCRIPTION**



CX3HGSM AT crystals in leadless ceramic packages are designed for surface mounting on PCB or hybrid substrates. The small footprint, low profile crystal has been designed for applications requiring high shock and vibration survival.

#### **OUTLINE & DIMENSIONS**



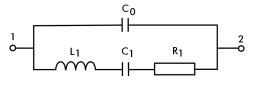
Glass Lid	Ceramic Lid
1.35	1.70
1.40	1.75
1.47	1.83
1.40	1.75
1.47	1.83
	1.35 1.40 1.47 1.40

## **PACKAGING OPTIONS**

CX3HGSM AT crystals are available either tray packed (<250pcs) or tape and reel (>250 pieces).

16mm tape, 178mm or 330mm reels (EIA 418).

#### **CRYSTAL EQUIVALENT CIRCUIT**



R1 Motional Resistance C1 Motional Capacitance L1 Motional Inductance C0 Shunt Capacitance

### **HOW TO ORDER CX3HGSM AT CRYSTALS**

